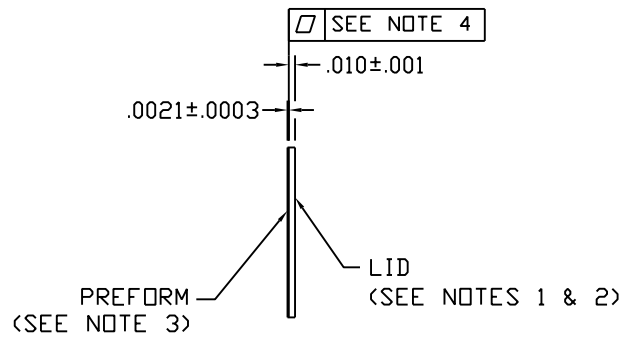
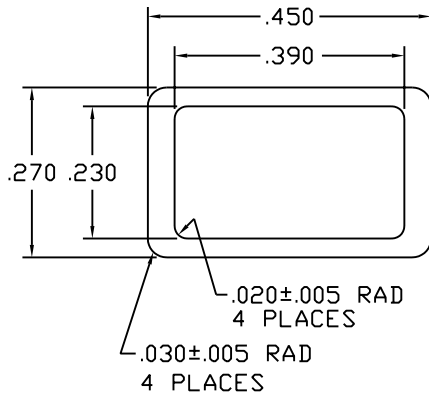


SSM P/N CL452601



NOTES

1. MAT'L : KOVAR OR ALLOY 42
 2. PLATING : 1st LAYER 50/350 MICROINCHES Ni
 2nd LAYER Au
 3rd LAYER 50/350 MICROINCHES Ni
 4th LAYER 25 MICROINCHES MINIMUM Au
- NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.
3. PREFORM - 80% ±1% Au
 20% Sn
 4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
 5. TOLERANCES TO BE (XXX) 3 PLACES ±.003 UNLESS OTHERWISE NOTED

DESIGN	BW	08/03 89	DESCRIPTION	Hi-Rel Combo Lid	
APPRO	VG	03/08 00	PART NAME	CL452702	SCALE 4 = 1
Spectrum Semiconductor Materials, Inc. 2027 O'Toole Ave San Jose, CA 95131 PH: (408) 435-5555 Fx: (408)435-8226			MFG: Semi-Alloys	DEPT	
			PART No.	HRC-672-21-25MT-100MNI-S	

